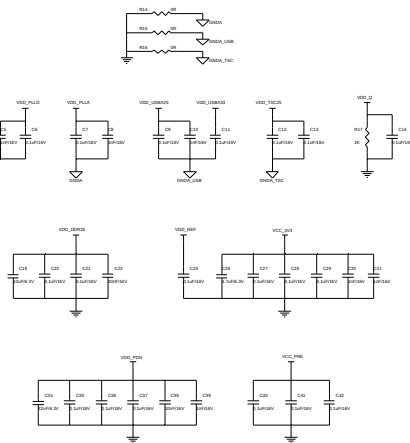
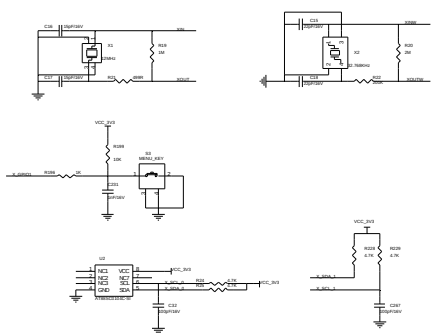
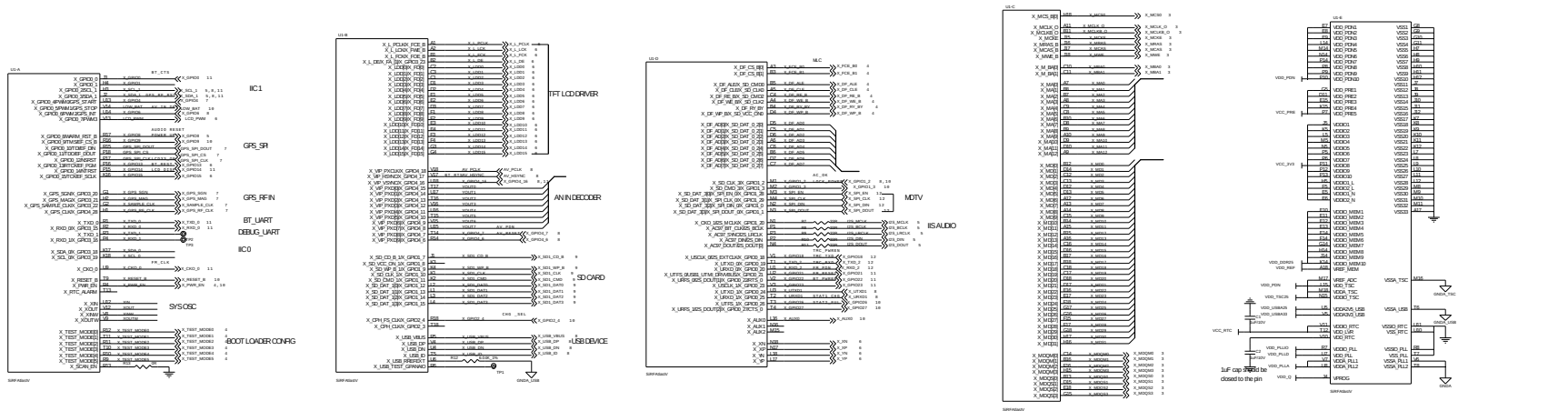
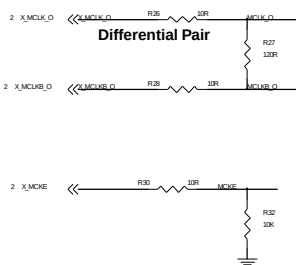
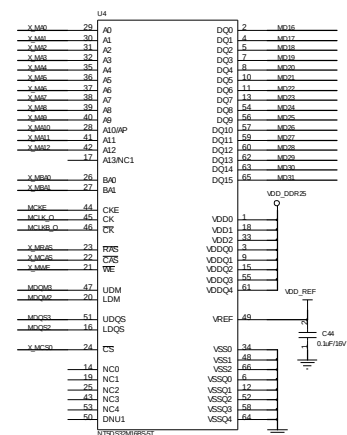
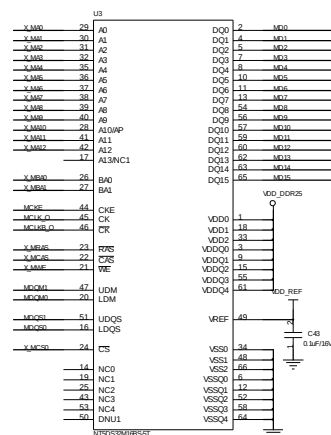


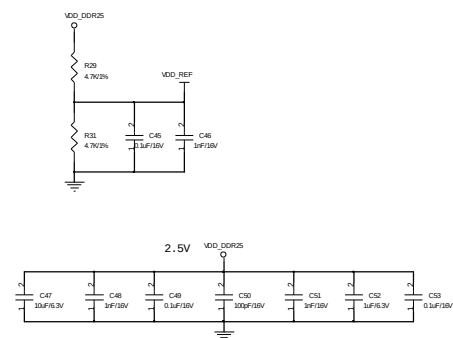
GC-32C V2.0				
CPU I/O & CPU POWER				
REV	DATE	DESIGNER	REVISION	DATE
1.0	2014	GC-32C	1.0	2014



RP1			
X.MD0	1	~	R.MD0
X.MD1	2	~	R.MD1
X.MD20	3	~	R.MD20
X.MD2	4	~	R.MD2
33AP401			
RP2			
X.MD3	1	~	R.MD3
X.MD4	2	~	R.MD4
X.MD5	3	~	R.MD5
X.MD30	4	~	R.MD30
33AP401			
RP3			
X.MD6	1	~	R.MD6
X.MD7	2	~	R.MD7
X.MD8	3	~	R.MD8
X.MD9	4	~	R.MD9
33AP401			
RP4			
X.MD31	1	~	R.MD31
X.MD32	2	~	R.MD32
X.MD33	3	~	R.MD33
X.MD34	4	~	R.MD34
33AP401			
RP5			
X.MD13	1	~	R.MD13
X.MD10	2	~	R.MD10
X.MD14	3	~	R.MD14
X.MD15	4	~	R.MD15
33AP401			
RP6			
X.MD16	1	~	R.MD16
X.MD17	2	~	R.MD17
X.MD18	3	~	R.MD18
X.MD19	4	~	R.MD19
33AP401			
RP7			
X.MD12	1	~	R.MD12
X.MD11	2	~	R.MD11
X.MD21	3	~	R.MD21
X.MD22	4	~	R.MD22
33AP401			
RP8			
X.MD23	1	~	R.MD23
X.MD24	2	~	R.MD24
X.MD25	3	~	R.MD25
X.MD26	4	~	R.MD26
33AP401			
RP9			
X.MD27	1	~	R.MD27
X.MD28	2	~	R.MD28
X.MD29	3	~	R.MD29
X.MD30	4	~	R.MD30
33AP401			
RP10			
X.MD31	1	~	R.MD31
X.MD32	2	~	R.MD32
X.MD33	3	~	R.MD33
X.MD34	4	~	R.MD34
33AP401			
RP11			
X.MD35	1	~	R.MD35
X.MD36	2	~	R.MD36
X.MD37	3	~	R.MD37
X.MD38	4	~	R.MD38
33AP401			
RP12			
X.MD39	1	~	R.MD39
X.MD40	2	~	R.MD40
X.MD41	3	~	R.MD41
X.MD42	4	~	R.MD42
33AP401			
RP13			
X.MD43	1	~	R.MD43
X.MD44	2	~	R.MD44
X.MD45	3	~	R.MD45
X.MD46	4	~	R.MD46
33AP401			
RP14			
X.MD47	1	~	R.MD47
X.MD48	2	~	R.MD48
X.MD49	3	~	R.MD49
X.MD50	4	~	R.MD50
33AP401			
RP15			
X.MD51	1	~	R.MD51
X.MD52	2	~	R.MD52
X.MD53	3	~	R.MD53
X.MD54	4	~	R.MD54
33AP401			
RP16			
X.MD55	1	~	R.MD55
X.MD56	2	~	R.MD56
X.MD57	3	~	R.MD57
X.MD58	4	~	R.MD58
33AP401			
RP17			
X.MD59	1	~	R.MD59
X.MD60	2	~	R.MD60
X.MD61	3	~	R.MD61
X.MD62	4	~	R.MD62
33AP401			
RP18			
X.MD63	1	~	R.MD63
X.MD64	2	~	R.MD64
X.MD65	3	~	R.MD65
X.MD66	4	~	R.MD66
33AP401			
RP19			
X.MD67	1	~	R.MD67
X.MD68	2	~	R.MD68
X.MD69	3	~	R.MD69
X.MD70	4	~	R.MD70
33AP401			
RP20			
X.MD71	1	~	R.MD71
X.MD72	2	~	R.MD72
X.MD73	3	~	R.MD73
X.MD74	4	~	R.MD74
33AP401			
RP			

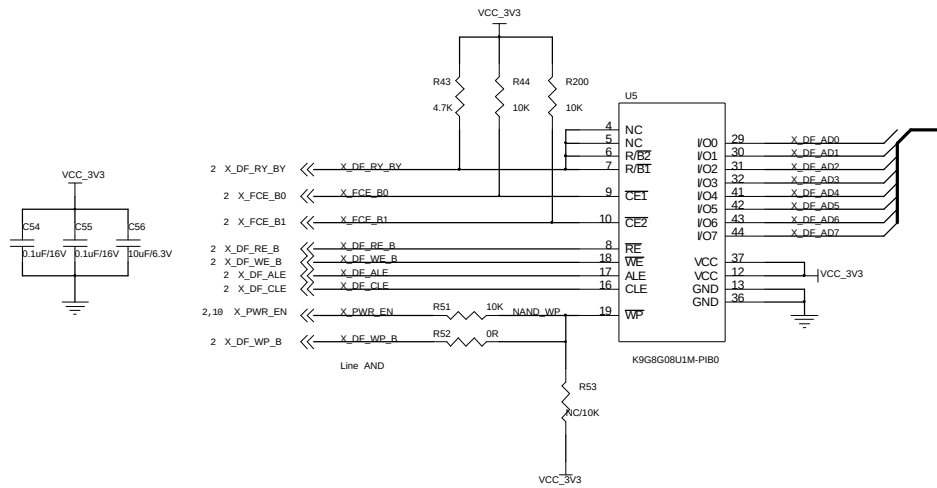


Default 64M byte
Part number is: NT5DS32M16BS-5T

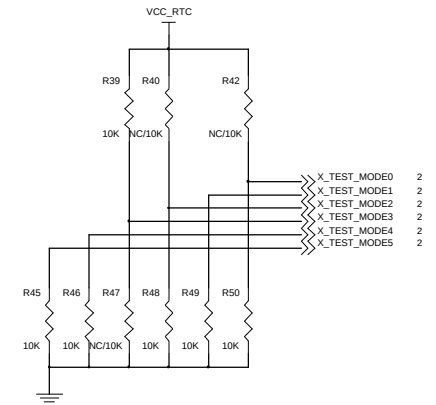


REV		GC-82C_V2.0			
REV A1	Document Number TITLE	DDR RAM			REV V2.0
DATE		Monday, April 10, 2006		PRINT	4 of 12
#PHONE		CHECK		DESIGN	SKY

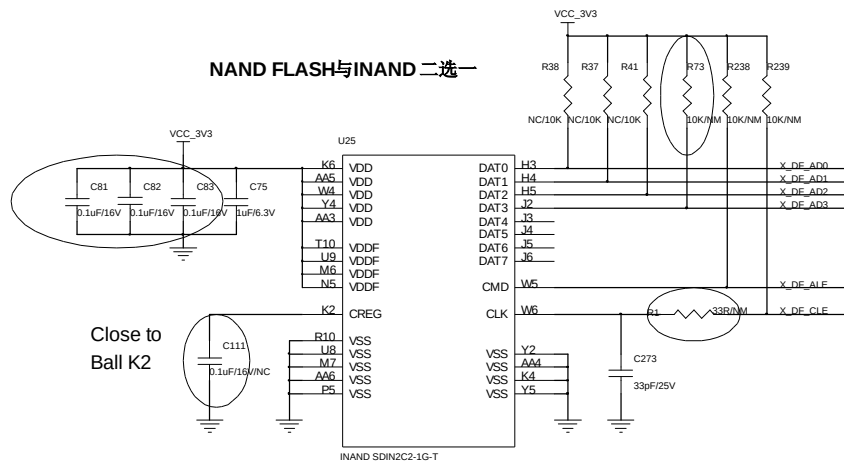
MLC Nand Flash boot Default



Boot Configure for three options



NAND FLASH与INAND 二选一

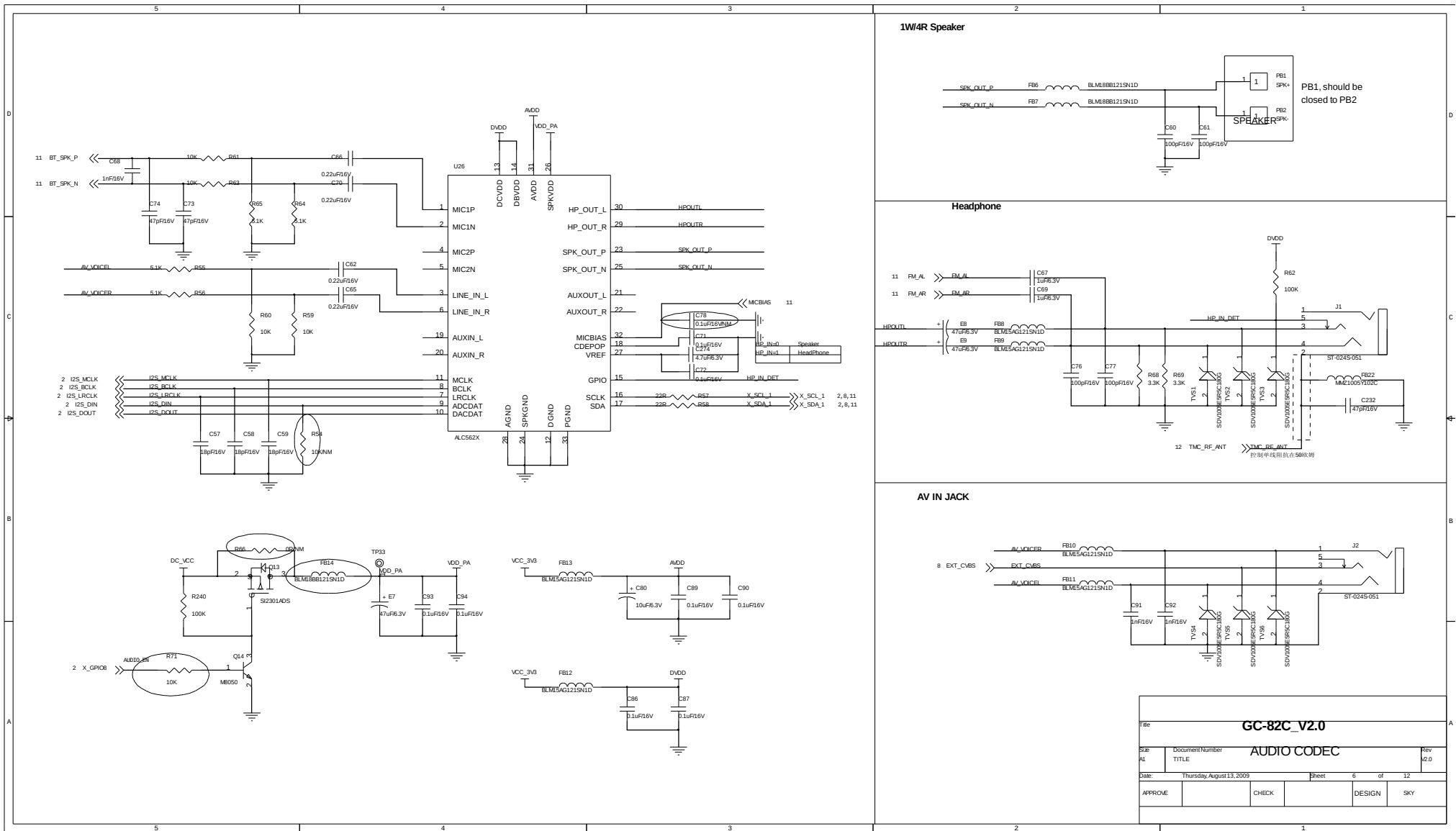


K9G8G08-----2K/page:
K9LAG08-----4K/page:

Default

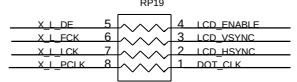
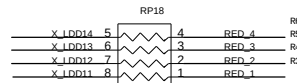
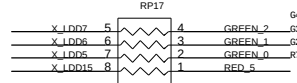
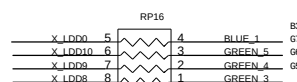
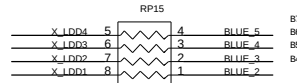
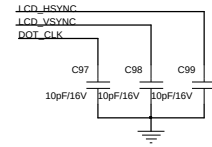
Boot configuration	X_TEST_MODE[5:0]
Boundary Scan	6b110000
SLC Nand Boot 2KB Page 8 Bit	6b000101
MLC Nand Boot 2KB Page 8 Bit	6b001000
INAND Boot	6b001100
EFuse	6b110010
MLC Nand Boot 4KB Page 8 Bit	6b001001

Title				GC-82C_V2.0			
Size	Document Number	NAND Flash&INAND				Rev	V1.0
A1	TITLE						
Date:	Tuesday, August 11, 2009	Sheet	5	of	12		
APPROVE		CHECK		DESIGN		SKY	

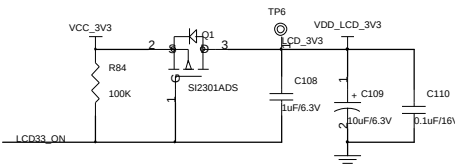


TFT LCD CONN

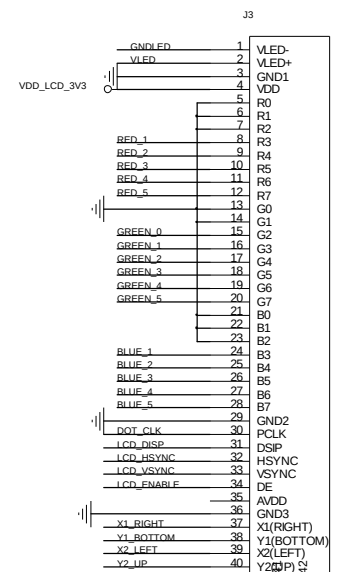
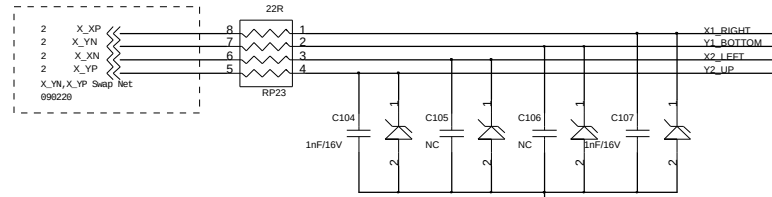
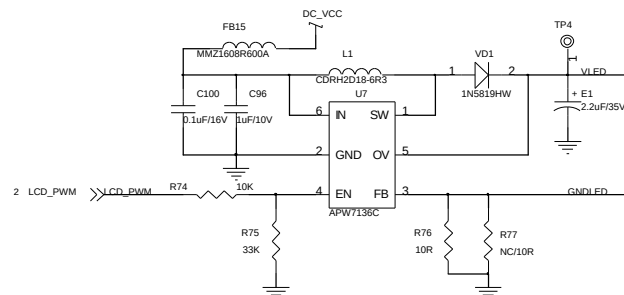
Connector type : 40Pin / 0.5mm pitch / Top contact



L_PCLK should be far away from other signal or be masked by GND



Inductor loop should be smaller, Input&output Width 10mil above



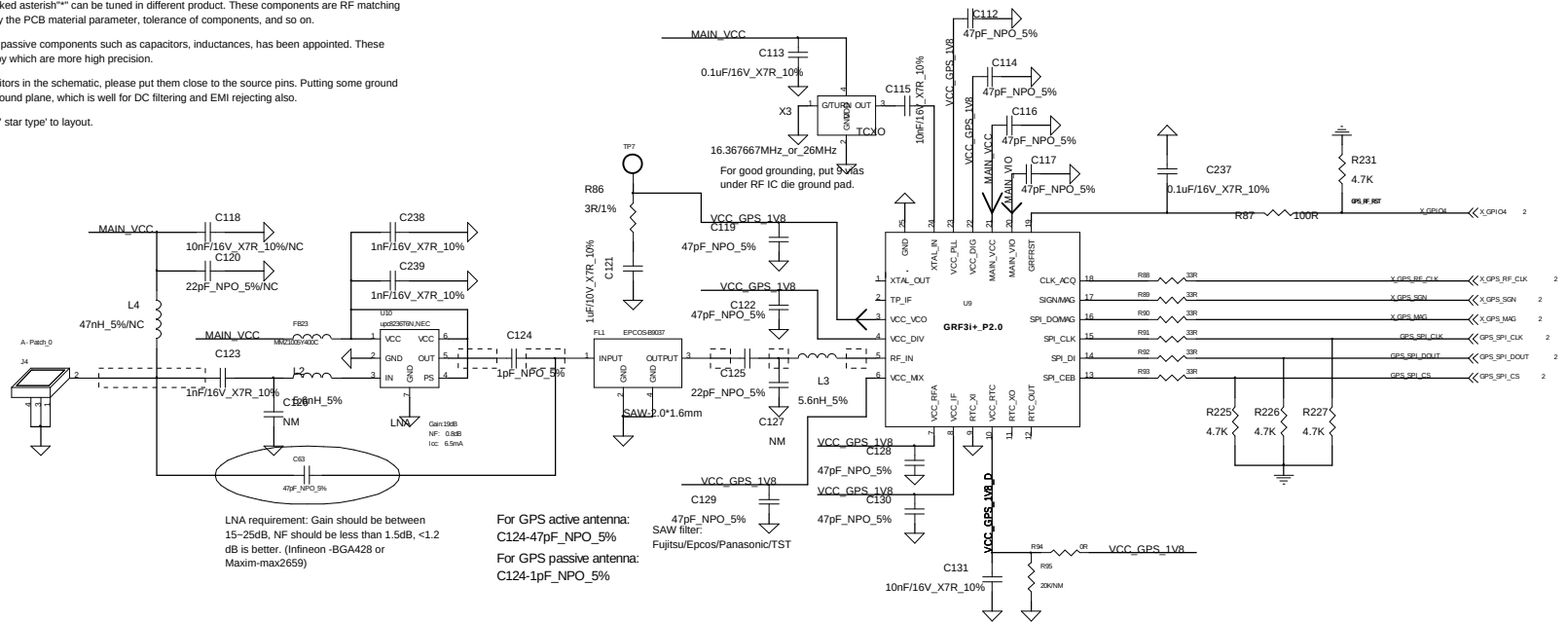
GC-82C_V2.0				
Size	Document Number	LCD DRIVER		Rev
A1	TITLE			V2.0
Date:	Monday, August 10, 2009	Sheet	7	of 12
APPROVE	CHECK	DESIGN	SKY	

Notes:

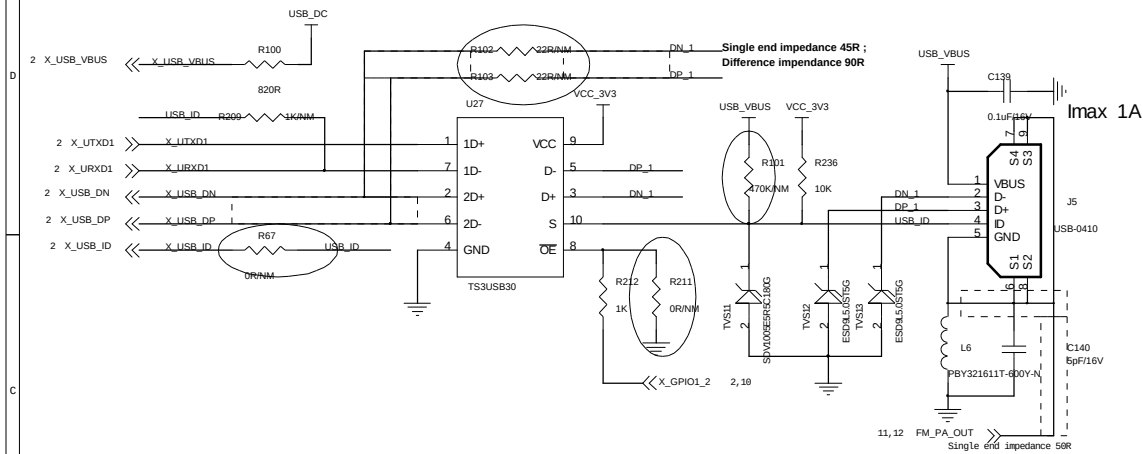
1. This page is RF module, Please pay more attention to PCB layout. The RF Z0 is 50 ohm, the drawing should follow RF rules and RF portion must be put into one shielding case.
2. The value of components with marked asterisk"" can be tuned in different product. These components are RF matching circuits, their values are influenced by the PCB material parameter, tolerance of components, and so on.
3. The characteristic and tolerance of passive components such as capacitors, inductances, has been appointed. These components just can be substituted by which are more high precision.
4. There are many DC filtering capacitors in the schematic, please put them close to the source pins. Putting some ground vias near to the ground pin and in ground plane, which is well for DC filtering and EMI rejecting also.
5. For 1.8V core voltage, please use 'star type' to layout.

TCXO will be 16.367667MHz or 26MHz, 0.5ppm KDS/TEW/Rakon TCX

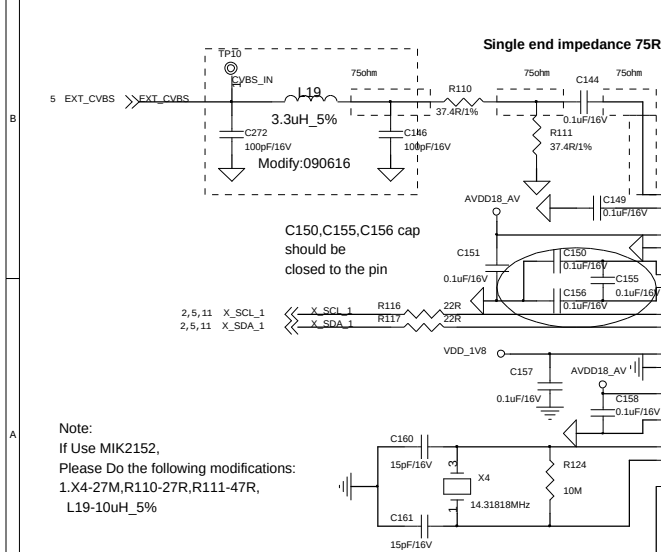
RF Microstrip
Z0= 50 ohm



USB OTG

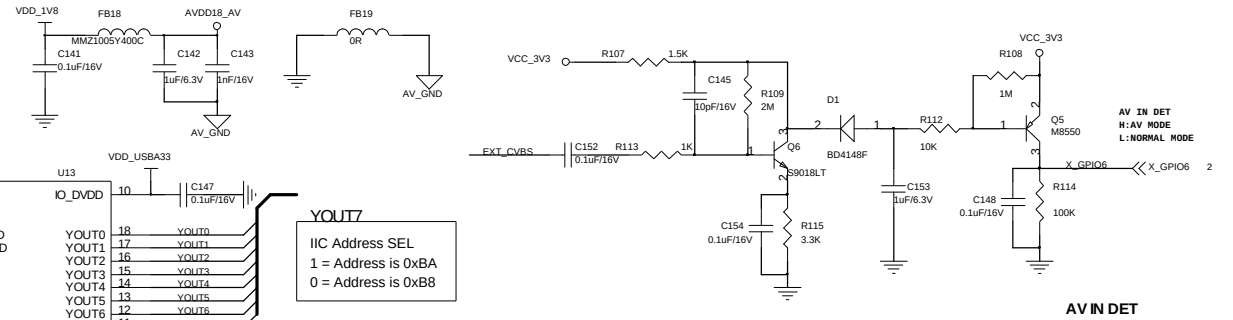
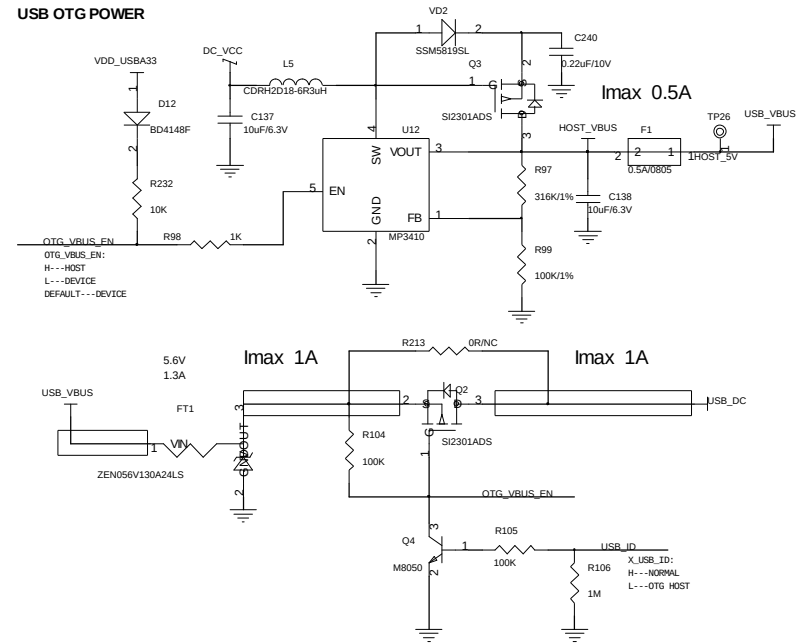


AV IN DECODER

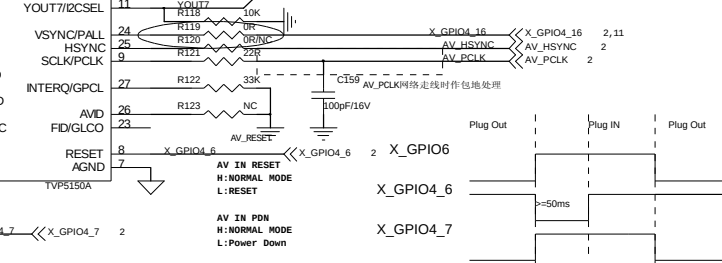


Note:
If Use MIK2152,
Please Do the following modifications:
1.X4-27M,R110-27R,R111-47R,
L19-10uH_5%

USB OTG POWER

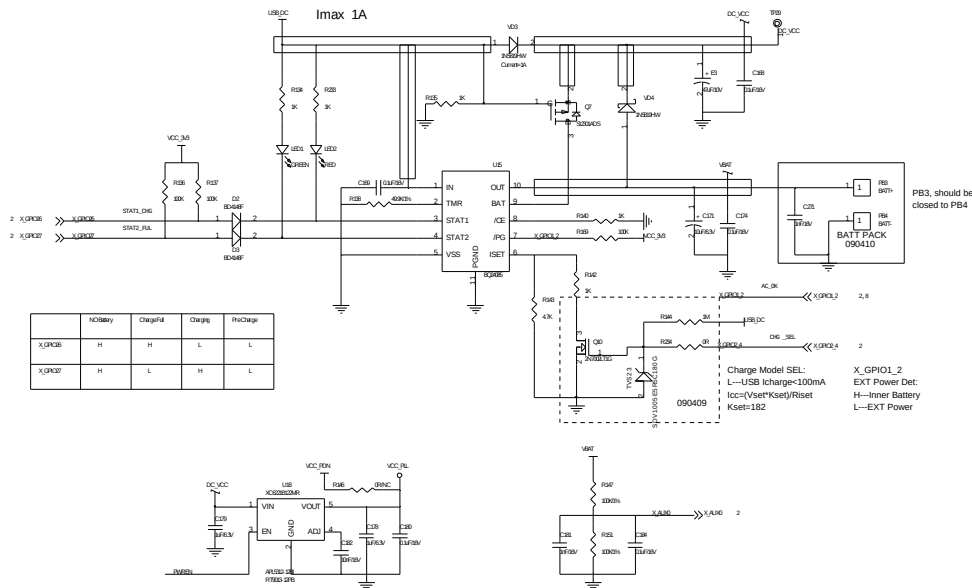


AV IN DET

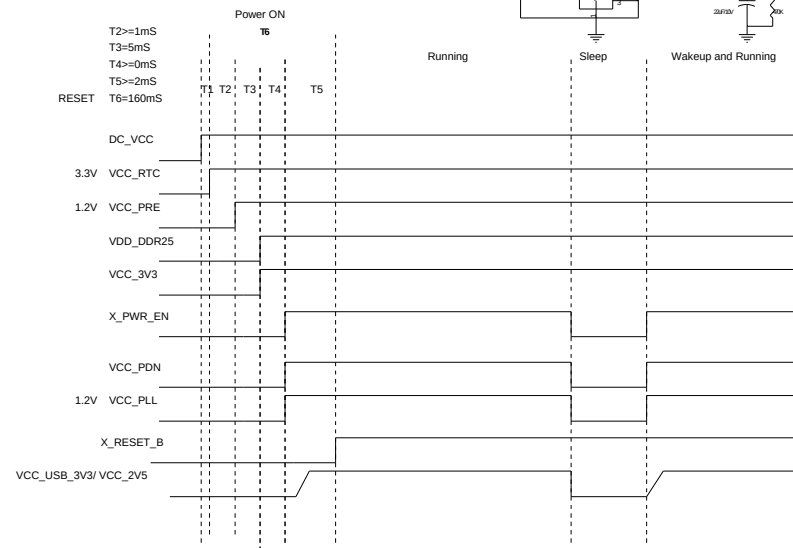
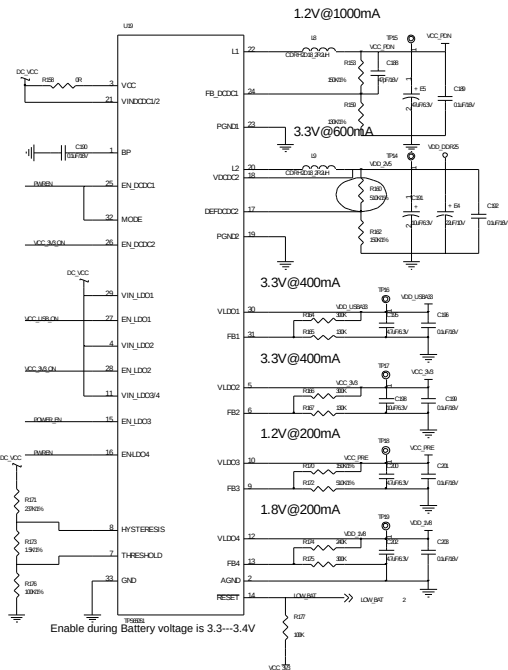
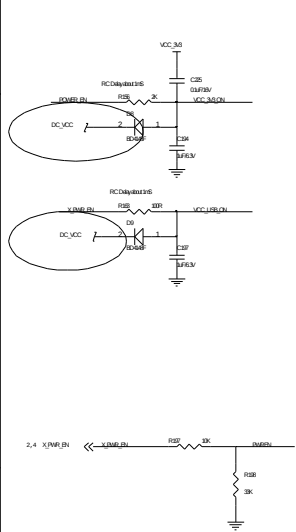
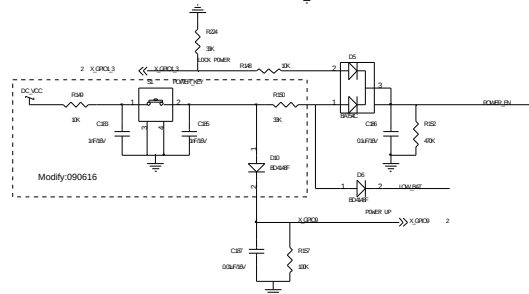
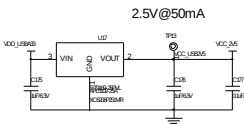
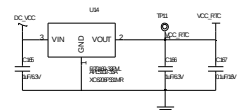


Title										GC-82C_V2.0												
Size A1		Document Number TITLE																USB&AV IN		Rev V2.0		
Date:					Monday, August 10, 2009										Sheet		9		of		12	
APPROVE								CHECK						DESIGN			SKY					

Title										GC-82C V2.0													
Size A1		Document Number TITLE										SD CARD										Rev V2.0	
Date: Monday, August 10, 2009										Sheet 10 of 12													
APPROVE								CHECK								DESIGN				SKY			

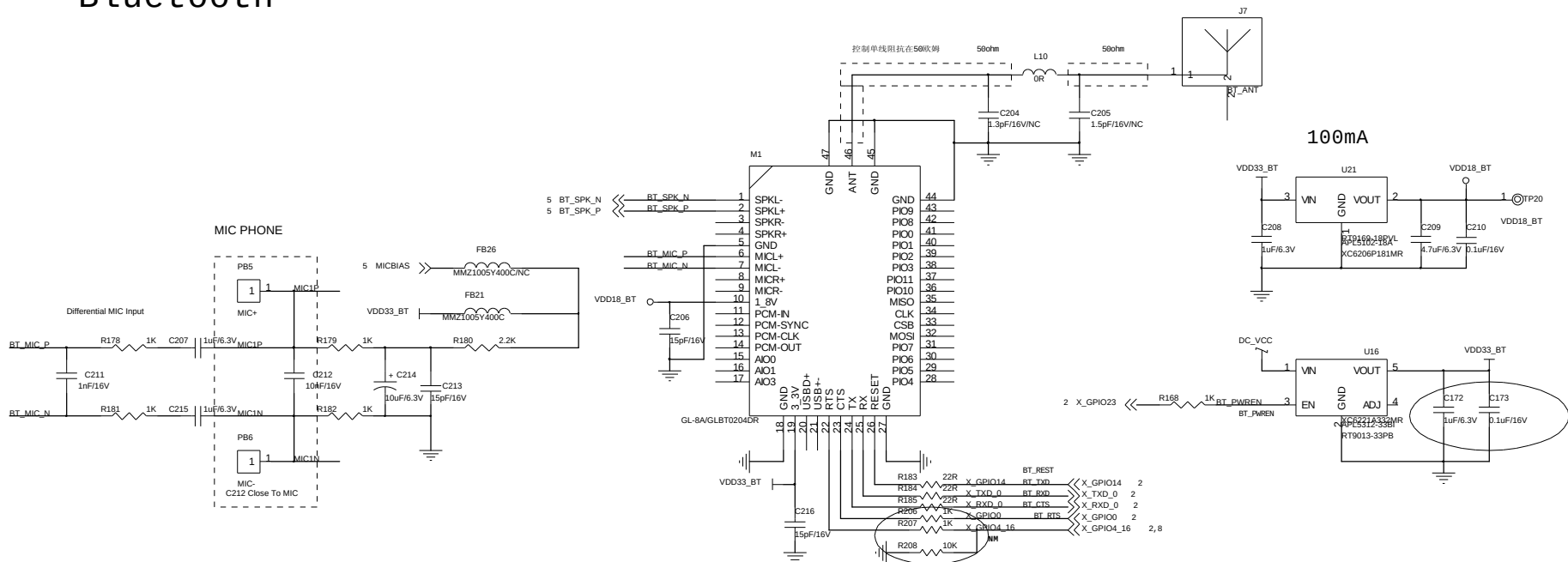


	NoBatt	ChargeFul	Charg	RevCharg
X_GPH01	H	H	L	L
X_GPH02	H	L	H	L



GC-82C V2.0									
POWER SUPPLY									
NO	DESCRIPTION	TIME	UNIT	MIN	MAX	TEST	VALUE	UNIT	VALUE
1	POWER ON	100ms	ms	100	1000	100	1000	ms	1000
2	POWER OFF	100ms	ms	100	1000	100	1000	ms	1000
3	POWER ON	100ms	ms	100	1000	100	1000	ms	1000
4	POWER OFF	100ms	ms	100	1000	100	1000	ms	1000

Bluetooth



GC-82C V2.0				
Title	BT			
Size	Document Number	BT		Rev
A1	TITLE			V2.0
Date:	Monday, August 10, 2009	Sheet	12	of 12
APPROVE		CHECK	DESIGN	SKY